

## IEEE 802.3 Ethernet Working Group

### Membership list

as of 24 August 2018

(231)

### Scope of the Working Group

The IEEE 802.3 Working Group is chartered to maintain and revise the Ethernet standard, develop new Ethernet standards in a reasonable time frame, forward these standards to ISO/IEC JTC1 SC6, and maintain liaisons with other groups within the IEEE 802 LAN/MAN Standards Committee and other relevant standards development organizations.

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